**Product Description**

Kester RF550 is a high-reliability, zero-halogen, no-clean rework flux designed for electronic component rework and repair applications. RF550 has a gel-like consistency and is packaged in syringes for easy dispensing. RF550 can be precisely dispensed onto specific areas that require flux. After being dispensed, RF550 stays in place until soldering occurs. RF550 has excellent performance in applications requiring high reliability. RF550 is the ideal choice for QFP or BGA semi-automated rework applications, and is well suited for use with through-hole repair. RF550 compliments Kester’s high reliability line of products which are formulated to leave safe residues. RF550 can be used in combinations with Kester no-clean flux-cored solder wires, no-clean solder pastes and no-clean liquid fluxes without any compatibility risks. For a list of compatible products, visit Kester website or contact Kester Technical Support.

**Performance Characteristics:**

- Zero-halogen (none intentionally added)
- Classified as ROLO per J-STD-004B

**RoHS Compliance**

This product meets the requirements of the Restriction of Hazardous Substances (RoHS) Directive, 2015/863 for the stated banned substances.

**Physical Properties**

- **Viscosity (typical):** 310 poise
  - Malcom Viscometer @ 10 rpm and 25°C
- **Acid Number (typical):** 162 mg KOH/g of flux
  - Tested to J-STD-004, IPC-TM-650, Method 2.3.13

**Reliability Properties**

- **Copper Mirror Corrosion:** Low
  - Test to J-STD-004B, IPC-TM-650, Method 2.3.32D
- **Corrosion Test:** Low
  - Test to J-STD-004B, IPC-TM-650, Method 2.6.15
- **Halogen Content:** None Detected
  - Test to J-STD-004B, IPC-TM-650, Method 2.3.2.81
- **Electrochemical Migration (ECM):** Pass
  - Test Conditions: 65+/−2°C; 85+3/-0 % RH
- **Bono Corrosion Test:** Pass; Fc=1.1%
  - Test Conditions: 85°C, 85% RH, 15 days, 12V
- **Bellcore SIR, IPC:** Pass
  - All Readings >2.0x10¹⁰ Ω
  - Tested to GR78 Core 13.1.3:
    - Test Conditions: 35°C, 85% RH, 4 days, 100V
- **Surface Insulation Resistivity (SIR):** Pass
  - Tested to J-STD-004B, IPC-TM-650, Method 2.6.3.7
  - Test Conditions: 40°C, 90% RH, 7 days, 12.5V
  - Tested to J-STD-004A, IPC-TM-650, Method 2.6.3.3
  - Test Conditions: 85°C, 85% RH, 7 days, 100V
**Cleaning**

RF550 is a no-clean formula. The residues do not need to be removed for typical applications. Although RF550 is designed for no-clean applications, its residues can be easily removed using automated cleaning equipment (in-line or batch) with a variety of readily available cleaning agents. If residue removal is required, call Kester Technical Support.

**Storage, Handling and Shelf Life**

Shelf life is 1 year from the date of manufacture when stored between 0-10°C (32-50°F).

**Health and Safety**

This product, during handling or use, may be hazardous to your health or the environment. Read the Safety Data Sheet and warning label before using this product.